

DECLARATION OF INVENTORSHIP

As a below-named inventor, We hereby declare that:

Our residence, post office address, and citizenship are as stated below next to our name; and

We verily believe that we are the original, first and joint inventors of the subject matter which is claimed and for which a patent is sought on the invention entitled: **METHOD FOR MOUNTING A DRIVER IC CHIP AND A FPC BOARD/TCP/COF DEVICE USING A SINGLE ANISTROPIC CONDUCTIVE FILM**, the specification of which:

☒ [X] is attached hereto.

☐ [] was filed on _____ as Application Serial No. _____ and
was amended on _____. (If applicable.)

We hereby state that We have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any Amendment referred to above.

We acknowledge the duty to disclose information which is material to the patentability of this application in accordance with 37 C.F.R. § 1.56.

We hereby claim foreign priority benefits under 35 U.S.C. § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of any application on which priority is claimed:

Country	Number	Date Filed	Priority Claimed ?

This application is a continuation-in-part pursuant to 35 USC §120 of each prior application (if any is identified) identified as follows:

Application	Filed
U.S. Serial No.: U.S. Filing Date:	Status:
U.S. Serial No.: U.S. Filing Date:	Status:

and we acknowledge the duty to disclose to the Office all information known to us to be material to patentability as defined in 37 CFR §1.56(a) which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

We hereby declare that all statements made herein of our own knowledge are true, and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

1	Full Name Ping-Chin Cheng	Inventor's Signature	Date
	Residence	Citizenship: TAIWAN	
	Post Office Address: (If same as residence, please write, "same as above") SAME AS ABOVE		
2	Full Name Hui Chang Chen	Inventor's Signature	Date
	Residence	Citizenship: TAIWAN	
	Post Office Address: (If same as residence, please write, "same as above") SAME AS ABOVE		